

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4773229

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
EN-TSUNG CHO	11/10/2017
KUN FAN	11/10/2017
YIQUN TIAN	11/10/2017
RECEIVING PARTY DATA	
Name:	HKC Corporation Limited
Street Address:	Huikie industrial park, Minying industrial park, Shuitian country, Shiyan,Baoan District
City:	Shenzhen
State/Country:	China
Postal Code:	
Name:	Chongqing HKC Optoelectronics Technology Co., Ltd.
Street Address:	No.3-1,4 building, No.16, Shigui Road, Jieshi Town Banan District
City:	Chongqing
State/Country:	China
Postal Code:	
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15869160
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	91014-029
NAME OF SUBMITTER:	JUSTIN KING
SIGNATURE:	/Justin King/

PATENT

DATE SIGNED:	01/12/2018
Total Attachments: 2 source=Assignment#page1.tif source=Assignment#page2.tif	

ASSIGNMENT

WHEREAS, ASSIGNOR,

1. EN-TSUNG CHO	, residing at	No.3-1,4 building, No.16, Shigui Road, Jieshi Town Banan District Chongqing China
2. FAN, KUN	, residing at	No.3-1,4 building, No.16, Shigui Road, Jieshi Town Banan District Chongqing China
3. YIQUN TIAN	, residing at	No.3-1,4 building, No.16, Shigui Road, Jieshi Town Banan District Chongqing China

(collectively referred to as ASSIGNOR),

owns all right, title and interest in the invention as disclosed and/or claimed in the U.S. patent application, entitled DISPLAY PANEL AND MANUFACTURING METHOD THEREOF, which

☒ is concurrently filed herewith; or

☐ was previously filed on _____ with Application No. _____;

AND, ASSIGNEE,

1. HKC Corporation Limited	, having offices at	Huik Industrial park, Minying industrial park, Shuitian country, Shiyao, Baoan District, Shenzhen, P.R.China
2. Chongqing HKC Optoelectronics Technology Co., Ltd.	, having offices at	No.3-1,4 building, No.16, Shigui Road, Jieshi Town Banan District Chongqing China

(collectively referred to as ASSIGNEE),

desires to own ASSIGNOR's entire right, title, and interest in and to the invention and in and to the above-described U.S. patent application.

NOW THEREFORE, be it known for one U.S. dollar (US\$1) and other good and valuable consideration, receipt of which is hereby acknowledged, ASSIGNOR hereby assigns, transfers and sets over to ASSIGNEE, its lawful successors and assigns, ASSIGNOR's entire right, title, and interest in and to the invention and the U.S. patent application as described above, and other patent application, including but not limited to any continuing application, directed or to be directed to the invention, and all Letters Patent of the United States that may be granted therein, and all reissues, reexaminations, and extensions thereof; and all rights to claim priority on the basis of such application; and all applications for Letters Patent that may be filed for the invention in any other country and all Letters Patent that may be granted on the invention in any other country, and all extensions, renewals, reissues thereof; and ASSIGNOR hereby authorizes

and requests the Commissioner for Patents of the United States and any official of any other country whose duty is to issue patents on patent applications, to issue all Letters Patent for this invention to ASSIGNEE, its successors and assigns, in accordance with the terms of this Assignment;

AND, ASSIGNOR HEREBY further covenants that ASSINOR has the full right to convey the interest assigned by this Assignment, ASSIGNOR will take all action and execute all documents necessary to perfect the interest assigned hereby, and ASSIGNOR has not executed and will not execute any agreement in conflict with this Assignment;

AND, ASSIGNOR HEREBY further covenants and agrees that ASSIGNOR will, without further consideration, communicate with ASSIGNEE, its successors and assigns, any facts known to ASSIGNOR respecting the invention and testify in any legal proceeding, sign all lawful papers that may be necessary or desirable to perfect the title to the invention in said ASSIGNEE, its successors and assigns, execute all rightful oaths, and generally do everything possible to aid ASSIGNEE, its successors and assigns, to prosecute any patent application described above and obtain and enforce proper patent protection for the invention in the United States and in any other country, it being understood that any expense incident to the execution of such papers shall be borne by ASSIGNEE, its successors and assigns.

IN TESTIMONY WHEREOF, ASSIGNOR has executed his Assignment the day and year below written.

EN-TSUNG CHO

[EN-TSUNG CHO]

Date: 2017.11.10

FAN KUN

[FAN, KUN]

Date: 2017.11.10

YIQUN TIAN

[YIQUN TIAN]

Date: 2017.11.10